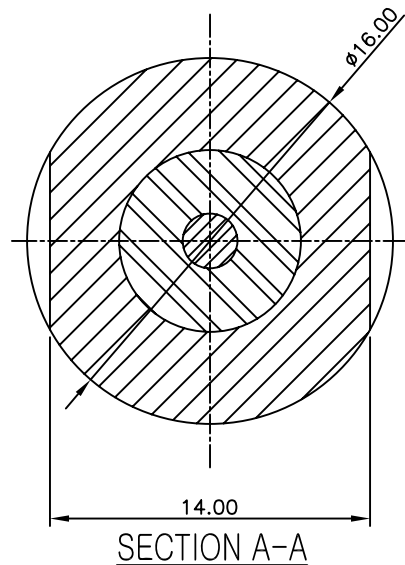
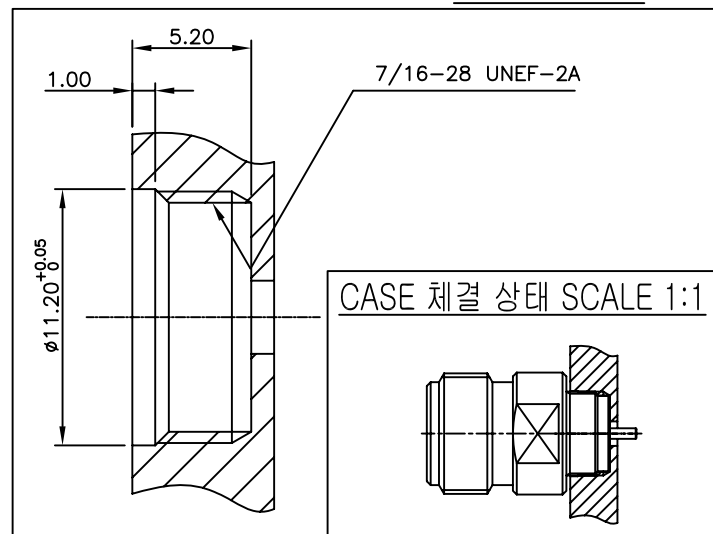


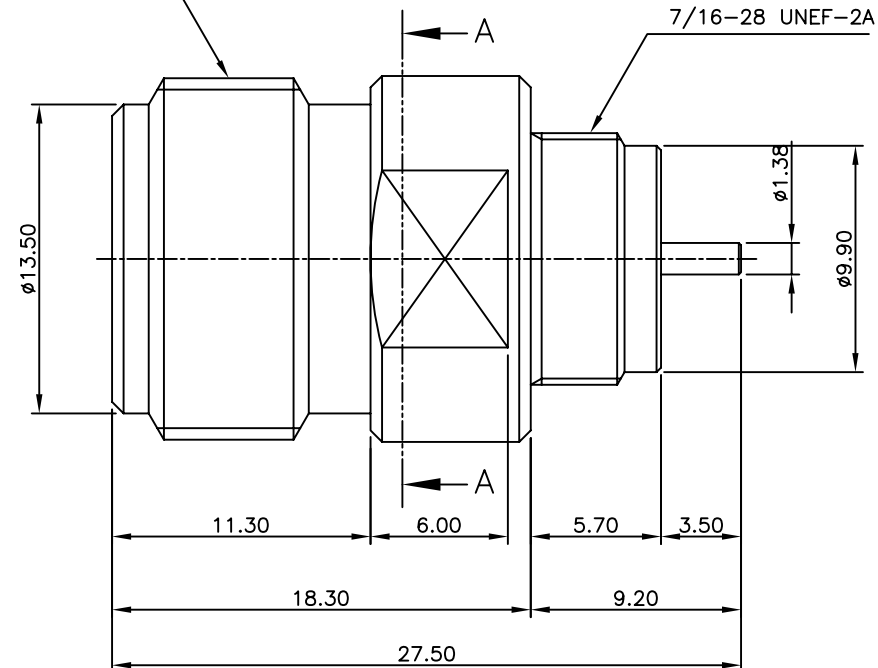
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2019. 07. 02.
1	조립공차 ±0.1 -> ±0.2 변경	S.Y.EUN	I.C.KIM	2020. 05. 13.



CASE 체결 치수



5/8-24 UNEF-2A



7/16-28 UNEF-2A

3	INSULATOR	1	TEFLON	White	DIN00670-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT00713-5/2
1	BODY	1	MBsBD C3604BD-F	SUCO Plate	DBD03409-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 05. 13.	
	Angle	APPROVED BY I.C.KIM	
MATERIAL	-	CHECKED BY	
		DRAWN BY S.Y.EUN	
FINISH	-	SCALE	UNIT
		3/1	mm



RF & MICROWAVE
TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE N50 SOLDER END JB (F/F)			
A4	DWG NO.	CN03048-7/3	
	REVISION	1	SHEET 1 of 1